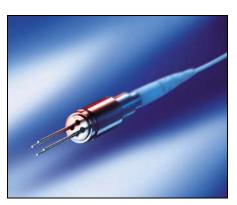


Ternary PIN Photodiode with integrated Preamplifier IC

SRP00294x SRP00295x

Features

- InGaAs/InP PIN photodiode with preamplifier IC
- Designed for SONET OC-48 / SDH STM-16 applications in fiber-optics communication systems
- Sensitive receiver for 2nd and 3rd optical window (1300 nm and 1550 nm)
- Suitable for bit rates up to 2.5 Gbit/s
- Module with high optical sensitivity
- · Fast switching times
- · Low dark current
- Excellent noise immunity
- High reverse current stability from planar structure
- Hermetically sealed TO46 package







Pin Configuration

Pin Configuration

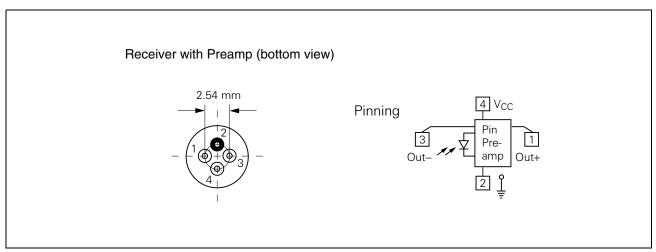


Figure 1 Receiver with Preamp



Description

Description

The Infineon optical receiver module has been designed for use in optical networks and is suitable for bit rates up to max. 2.5 Gbit/s if used without any TIA.

The optical receiver module uses a high-speed PIN photodetector optional coupled with a hybrid low noise transimpedance amplifier (PIN-TIA). The optical receiver photodiode can be used for 1310 nm or 1550 nm optical communications.

The PIN photodiode is made of InGaAs/InP and has an active diameter of 75 μ m. The function of the PIN and PIN-TIA optical receiver module is to detect input optical power, to transduce the incident radiation into current (PIN) and then to convert the current into a voltage (PIN-TIA).

The low input noise current density of the used transimpedance amplifiers in PIN-TIA's provides the optical receiver module, when used with appropriate filtering, with ample sensitivity for realizing minimum input power requirements. Designers of optical receivers can use the module in any application that benefits from integration of the photodiode and TIA into a TO coaxial package. Typical for such applications are receivers for digital crossconnects, digital loop carriers, add/drop-multiplexers and optical network units.

Last but not least the fast switching times, low dark currents and the packaging in a compact and hermetically sealed TO46 make the optical receivers usable in many other fiber optic receiver applications. One application is the use in a Compact realization of a transceiver in one module like the so called BIDI® (Figure 2).

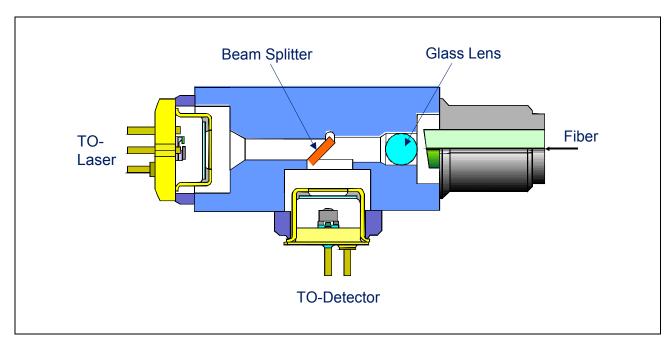


Figure 2 Compact Realization of the Transceiver in One Module



Technical Data

Technical Data

Absolute Maximum Ratings

Module $T_{\rm C}$ <t< th=""><th rowspan="2">Parameter</th><th rowspan="2">Symbol</th><th colspan="2">Limit Values</th><th>Unit</th></t<>	Parameter	Symbol	Limit Values		Unit
Operating temperature range at case $T_{\rm C}$ —40 85 Storage temperature range $T_{\rm stg}$ —40 85 Soldering temperature ($t_{\rm max}$ = 10 s, $T_{\rm S}$ 260 2 mm distance from bottom edge of case) Receiver Diode Reverse Voltage $V_{\rm R}$ 20			min.	max.	
Storage temperature range $T_{\rm stg}$ —40 85 Soldering temperature ($t_{\rm max}$ = 10 s, $T_{\rm S}$ 260 2 mm distance from bottom edge of case) Receiver Diode Reverse Voltage $V_{\rm R}$ 20	Module		1	-	,
Soldering temperature ($t_{\text{max}} = 10 \text{ s}$, T_{S} 260 2 mm distance from bottom edge of case) Receiver Diode Reverse Voltage V_{R} 20	Operating temperature range at case	T_{C}	-40	85	°C
2 mm distance from bottom edge of case) Receiver Diode Reverse Voltage $V_{\rm R}$ 20	Storage temperature range	$T_{ m stg}$	-40	85	
Reverse Voltage V_{R} 20	· max	$T_{\mathbb{S}}$		260	
The state of the s	Receiver Diode	•	•	•	•
	Reverse Voltage	V_{R}		20	V
Forward Current I _F 10	orward Current	I_{F}		10	mA
Optical power into the optical port $P_{ m port}$ 1	Optical power into the optical port	P_{port}		1	mW

The electro-optical characteristics described in the following table are only valid for use within the specified maximum ratings or under the recommended operating conditions. Characteristics for Pin-Preamp Receivers at $T_{\rm A}$ = 25°C, unless otherwise specified.

Preamp Characteristics

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
DC-Characteristics		•			•
Supply Voltage	$V_{\sf CC}$	4.5	5	5.5	V
Supply Current	$I_{\rm CC}$	35	47	65	mA
AC-Characteristics		•			•
Optical Sensitivity (BER ≤ 10 ⁻⁹ , PN23)	S		-22		dBm
Linear Bandwidth (-3 dB)	BW	1200	1600		MHz
Optical overload (avg.)	P_{max}		0		dBm
Transimpedance (single ended)	R_{T}	9	13	17	kΩ
Output resistance	R_{out}	40	50	60	Ω
Noise current density			3		pa/√Hz
Gain (differential)	G	11	21	34	V/mW
Return Loss, $\lambda = 1310 \text{ nm}$	RL			-27	dB



Technical Data

Some Eye Diagrams

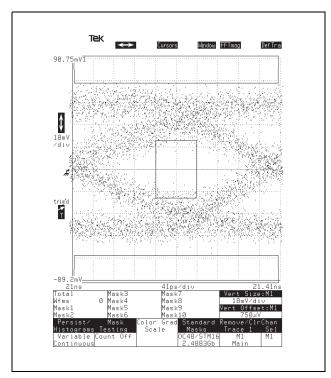


Figure 3 $P_{\text{opt}} = 5 \mu\text{W avg.}$ (OC-48/STM-16)

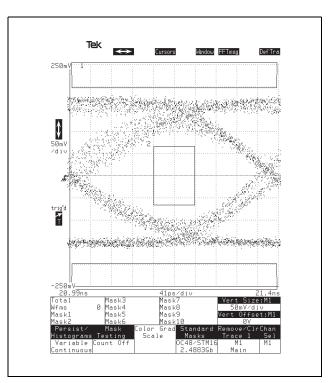


Figure 5 $P_{\text{opt}} = 10 \,\mu\text{W}$ avg. (OC-48/STM-16)

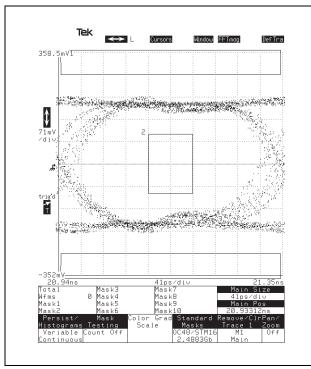


Figure 4 $P_{\text{opt}} = 100 \,\mu\text{W}$ avg. (OC-48/STM-16)

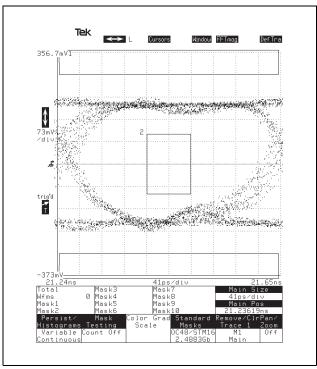


Figure 6 P_{opt} = 500 μ W avg. (OC-48/STM-16)



Fiber Data

Fiber Data

The mechanical fiber characteristics are described in the following table.

Fiber Characteristics

Parameter	Limit Values			Unit
	min.	typ.	max.	
Mode Field Diameter		50		μm
Cladding Diameter	123	125	127	
Mode Field/Cladding Concentricity Error			1	
Cladding Non-circularity			2	%
Mode Field Non-circularity			6	
Cut off Wavelength	1270			nm
Jacket Diameter	0.8		1	mm
Bending Radius	30			
Tensile Strength Fiber Case	5			N
Length	0.8		1.2	m



Package Outlines

Package Outlines

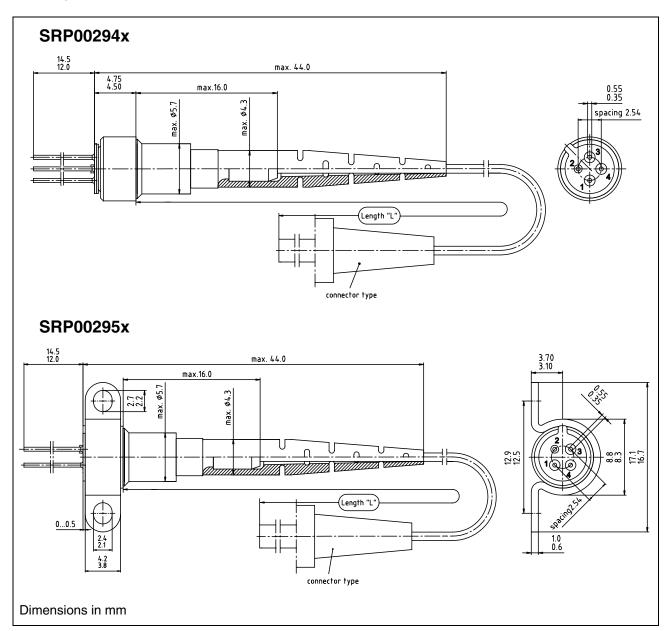


Figure 7



Package Outlines

Flange Options

Туре	Flange
SRP00294x	without
SRP00295x	with

Connector Options

Model	Туре	
SRP00294H SRP00295H	MM FC/PC	
SRP00294G SRP00295G	SM FC/PC	
SRP00294O SRP00295O	MM SC/PC 0°	
SRP00294N SRP00295N	SM SC/PC 0°	
SRP00294Q SRP00295Q	MM SC 8° APC	
SRP00294P SRP00295P	SM SC 8° APC	
SRP00294W SRP00295W	MM without connector	
SRP00294Z SRP00295Z	SM without connector	

Other connectors on request

SRP00294x
SRP00295x
Revision History: 2001-12-01
Previous Version:

DS₀

Page	Subjects (major changes since last revision)
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